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Please note: As part of the Fairchild Semiconductor integration, some of the Fairchild orderable part numbers will need to change in order to meet ON Semiconductor's system requirements. Since the ON Semiconductor product management systems do not have the ability to manage part nomenclature that utilizes an underscore (_), the underscore (_) in the Fairchild part numbers will be changed to a dash (-). This document may contain device numbers with an underscore (_). Please check the ON Semiconductor website to verify the updated device numbers. The most current and up-to-date ordering information can be found at www.onsemi.com. Please email any questions regarding the system integration to Fairchild_questions@onsemi.com.

FAIRCHILD SEMICONDUCTOR®

March 2013

FQP17P10

P-Channel QFET® MOSFET

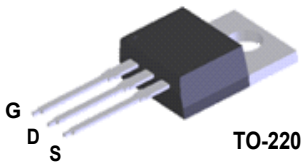
- 100 V, - 16.5 A, 190 mΩ

Description

This P-Channel enhancement mode power MOSFET is produced using Fairchild Semiconductor®'s proprietary planar stripe and DMOS technology. This advanced MOSFET technology has been especially tailored to reduce on-state resistance, and to provide superior switching performance and high avalanche energy strength. These devices are suitable for switched mode power supplies, audio amplifier, DC motor control, and variable switching power applications.

Features

- -16.5 A, -100 V, $R_{DS(on)}$ = 190 mΩ (Max.) @V_{GS} = -10 V, I_D = - 8.25 A
- Low Gate Charge (Typ. 30 nC)
- Low Crss (Typ. 100 pF)
- 100% Avalanche Tested
- 175°C Maximum Junction Temperature Rating



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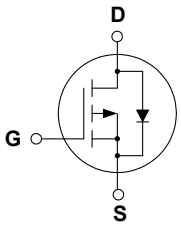


Absolute Maximum Ratings

T_C = 25°C unless otherwise noted

Symbol	Parameter			FQP17P10	Unit
V_{DSS}	Drain-Source Voltage			-100	V
I_D	Drain Current	- Continuous (T_C = 25°C)		-16.5	A
		- Continuous (T_C = 100°C)		-11.7	A
I_{DM}	Drain Current	- Pulsed	(Note 1)	-66	A
V_{GSS}	Gate-Source Voltage			± 30	V
E_{AS}	Single Pulsed Avalanche Energy		(Note 2)	580	mJ
I_{AR}	Avalanche Current		(Note 1)	-16.5	A
E_{AR}	Repetitive Avalanche Energy		(Note 1)	10	mJ
dv/dt	Peak Diode Recovery dv/dt		(Note 3)	-6.0	V/ns
P_D	Power Dissipation (T_C = 25°C)			100	W
	- Derate above 25°C			0.67	W/°C
T_J, T_{STG}	Operating and Storage Temperature Range			-55 to +175	°C
T_L	Maximum lead temperature for soldering purposes, 1/8" from case for 5 seconds			300	°C

Thermal Characteristics

Symbol	Parameter	FQP17P10	Unit
$R_{\theta JC}$	Thermal Resistance, Junction-to-Case, Max.	1.5	°C/W
$R_{\theta CS}$	Thermal Resistance, Case-to-Sink, Typ.	0.5	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient, Max.	62.5	°C/W

Electrical Characteristics

T_C = 25°C unless otherwise noted

Symbol	Parameter	Test Conditions	Min	Typ	Max	Unit
Off Characteristics						
BV_{DSS}	Drain-Source Breakdown Voltage	V_{GS} = 0 V, I_D = -250 μA	-100	--	--	V
ΔBV_{DSS} / ΔT_J	Breakdown Voltage Temperature Coefficient	I_D = -250 μA, Referenced to 25°C	--	-0.1	--	V/°C
I_{DSS}	Zero Gate Voltage Drain Current	V_{DS} = -100 V, V_{GS} = 0 V	--	--	-1	μA
		V_{DS} = -80 V, T_C = 150°C	--	--	-10	μA
I_{GSSF}	Gate-Body Leakage Current, Forward	V_{GS} = -30 V, V_{DS} = 0 V	--	--	-100	nA
I_{GSSR}	Gate-Body Leakage Current, Reverse	V_{GS} = 30 V, V_{DS} = 0 V	--	--	100	nA
On Characteristics						
$V_{GS(th)}$	Gate Threshold Voltage	V_{DS} = V_{GS}, I_D = -250 μA	-2.0	--	-4.0	V
$R_{DS(on)}$	Static Drain-Source On-Resistance	V_{GS} = -10 V, I_D = -8.25 A	--	0.14	0.19	Ω
g_{FS}	Forward Transconductance	V_{DS} = -40 V, I_D = -8.25 A	--	9.9	--	S
Dynamic Characteristics						
C_{iss}	Input Capacitance	V_{DS} = -25 V, V_{GS} = 0 V, f = 1.0 MHz	--	850	1100	pF
C_{oss}	Output Capacitance		--	310	400	pF
C_{rss}	Reverse Transfer Capacitance		--	100	130	pF
Switching Characteristics						
$t_{d(on)}$	Turn-On Delay Time	V_{DD} = -50 V, I_D = -16.5 A, R_G = 25 Ω (Note 4)	--	17	45	ns
t_r	Turn-On Rise Time		--	200	410	ns
$t_{d(off)}$	Turn-Off Delay Time		--	45	100	ns
t_f	Turn-Off Fall Time		--	100	210	ns
Q_g	Total Gate Charge	V_{DS} = -80 V, I_D = -16.5 A, V_{GS} = -10 V (Note 4)	--	30	39	nC
Q_{gs}	Gate-Source Charge		--	4.8	--	nC
Q_{gd}	Gate-Drain Charge		--	17	--	nC
Drain-Source Diode Characteristics and Maximum Ratings						
I_S	Maximum Continuous Drain-Source Diode Forward Current		--	--	-16.5	A
I_{SM}	Maximum Pulsed Drain-Source Diode Forward Current		--	--	-66	A
V_{SD}	Drain-Source Diode Forward Voltage	V_{GS} = 0 V, I_S = -16.5 A	--	--	-4.0	V
t_{rr}	Reverse Recovery Time	V_{GS} = 0 V, I_S = -16.5 A, dI_F / dt = 100 A/μs	--	120	--	ns
Q_{rr}	Reverse Recovery Charge		--	0.52	--	μC

Notes:
1. Repetitive Rating : Pulse width limited by maximum junction temperature
2. L = 3.2mH, I_{AS} = -16.5A, V_{DD} = -25V, R_G = 25 Ω, Starting T_J = 25°C
3. $I_{SD} \leq$ -16.5A, di/dt $\leq$ 300A/μs, $V_{DD} \leq BV_{DSS}$, Starting T_J = 25°C
4. Essentially independent of operating temperature

Typical Characteristics

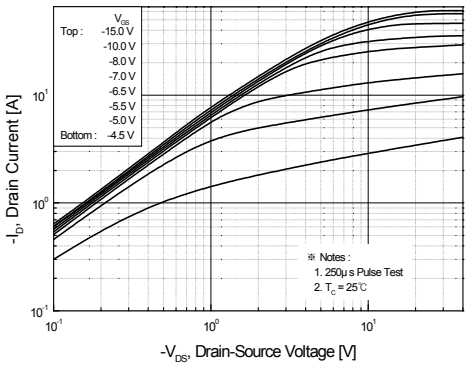


Figure 1. On-Region Characteristics

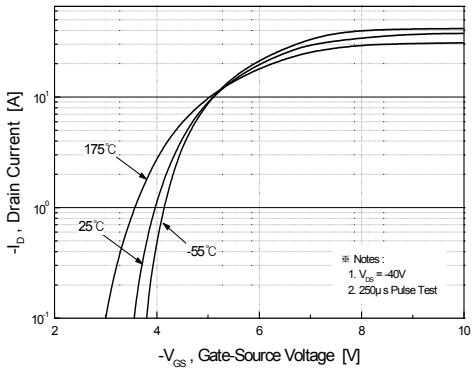


Figure 2. Transfer Characteristics

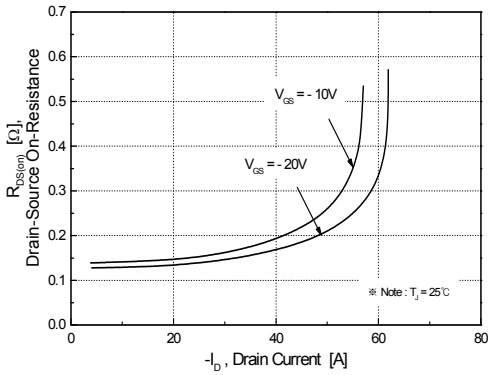


Figure 3. On-Resistance Variation vs. Drain Current and Gate Voltage

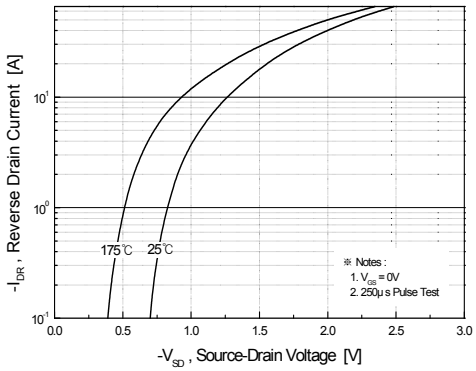


Figure 4. Body Diode Forward Voltage Variation vs. Source Current and Temperature

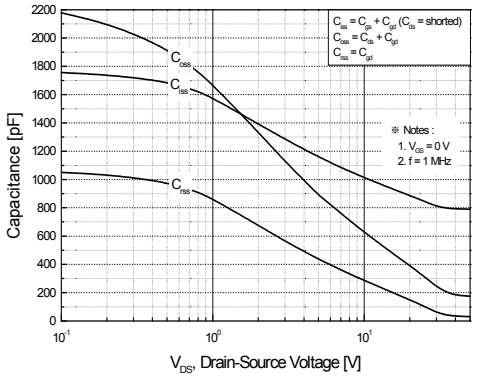


Figure 5. Capacitance Characteristics

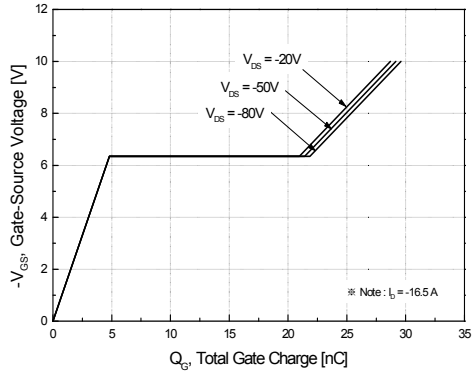


Figure 6. Gate Charge Characteristics

Dimensions in Millimeters

Typical Characteristics (Continued)

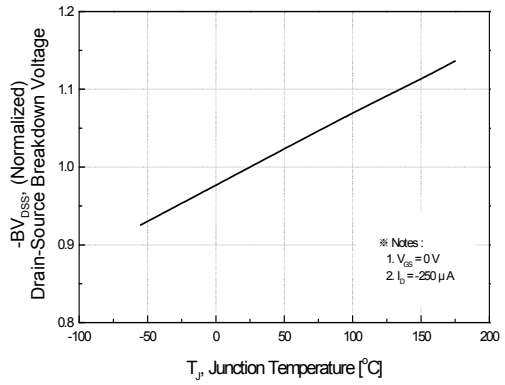


Figure 7. Breakdown Voltage Variation vs. Temperature

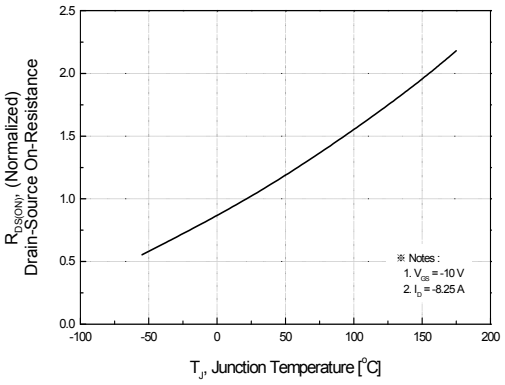


Figure 8. On-Resistance Variation vs. Temperature

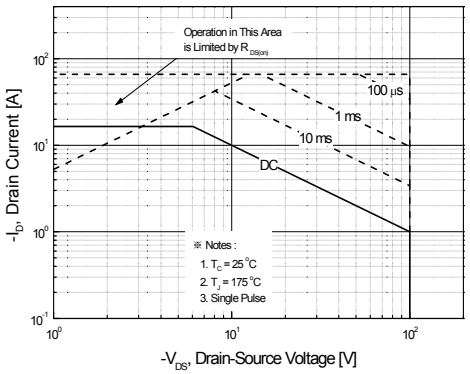


Figure 9. Maximum Safe Operating Area

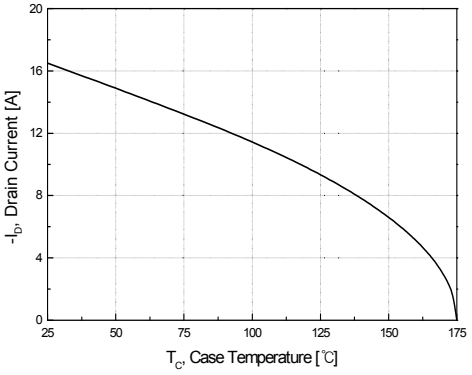


Figure 10. Maximum Drain Current vs. Case Temperature

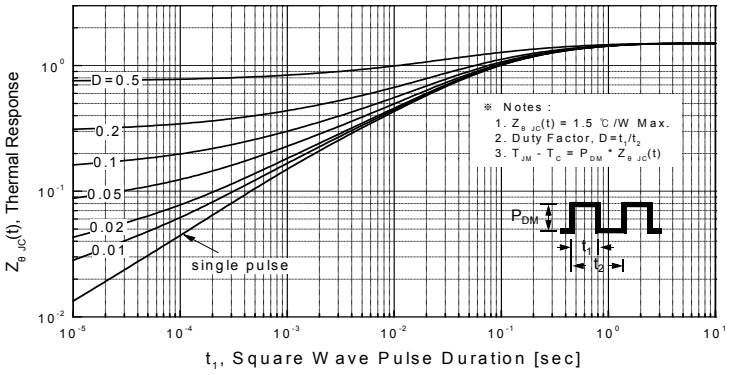
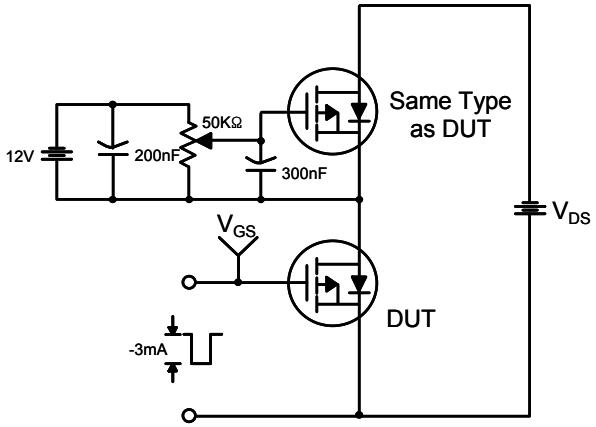
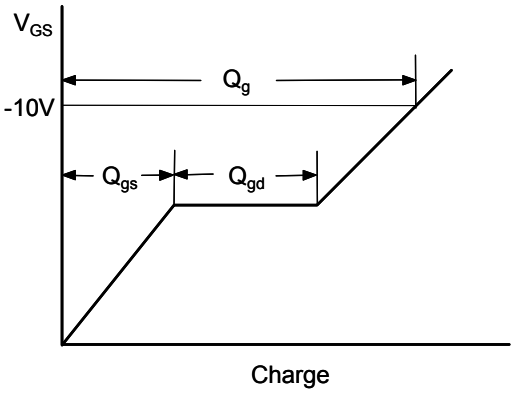


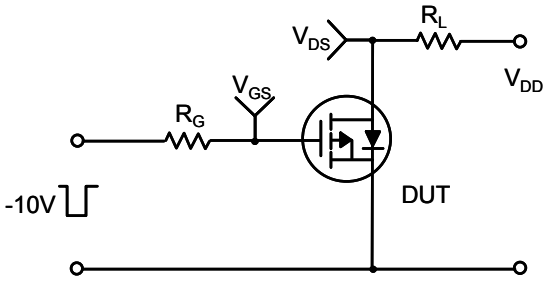
Figure 11. Transient Thermal Response Curve

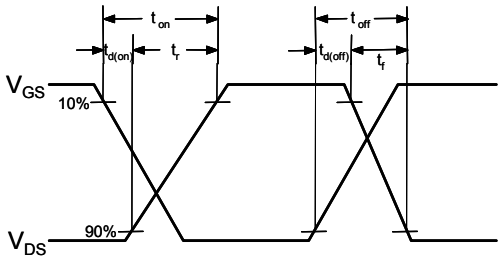
Gate Charge Test Circuit & Waveform



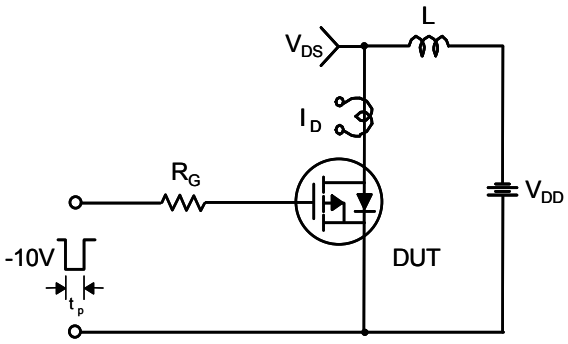


Resistive Switching Test Circuit & Waveforms

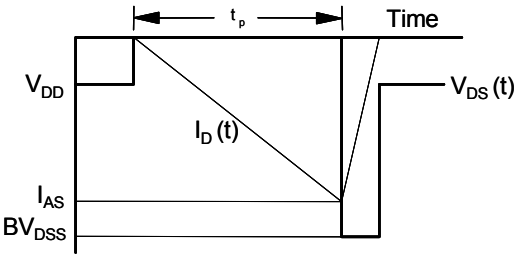




Unclamped Inductive Switching Test Circuit & Waveforms

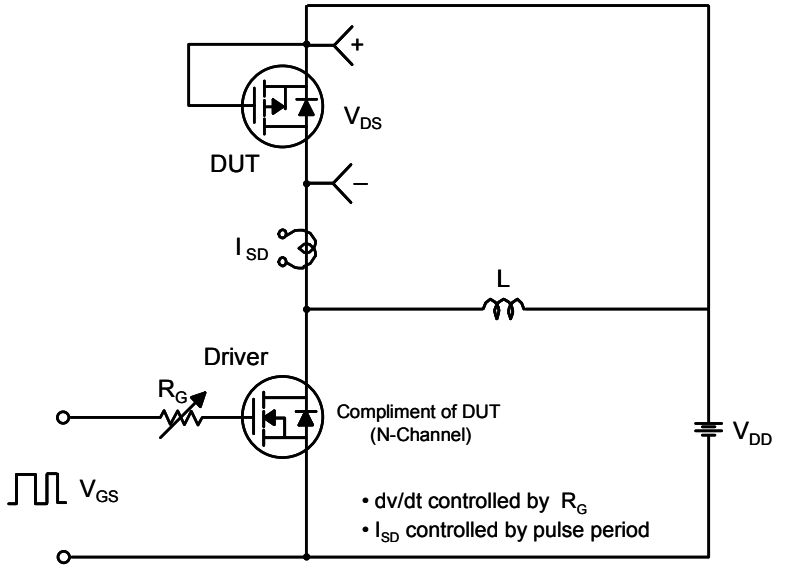


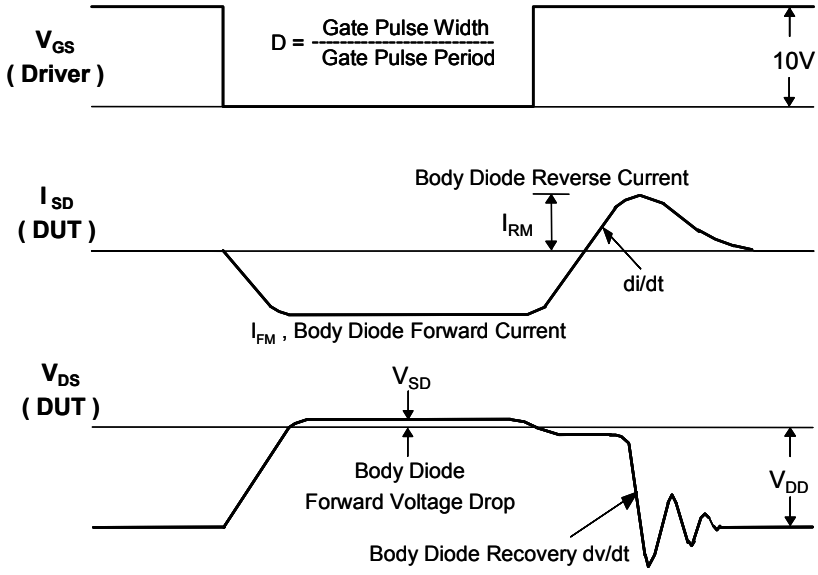
$$E_{AS} = \frac{1}{2} L I_{AS}^2 \frac{BV_{DSS}}{BV_{DSS} - V_{DD}}$$



Dimensions in Millimeters

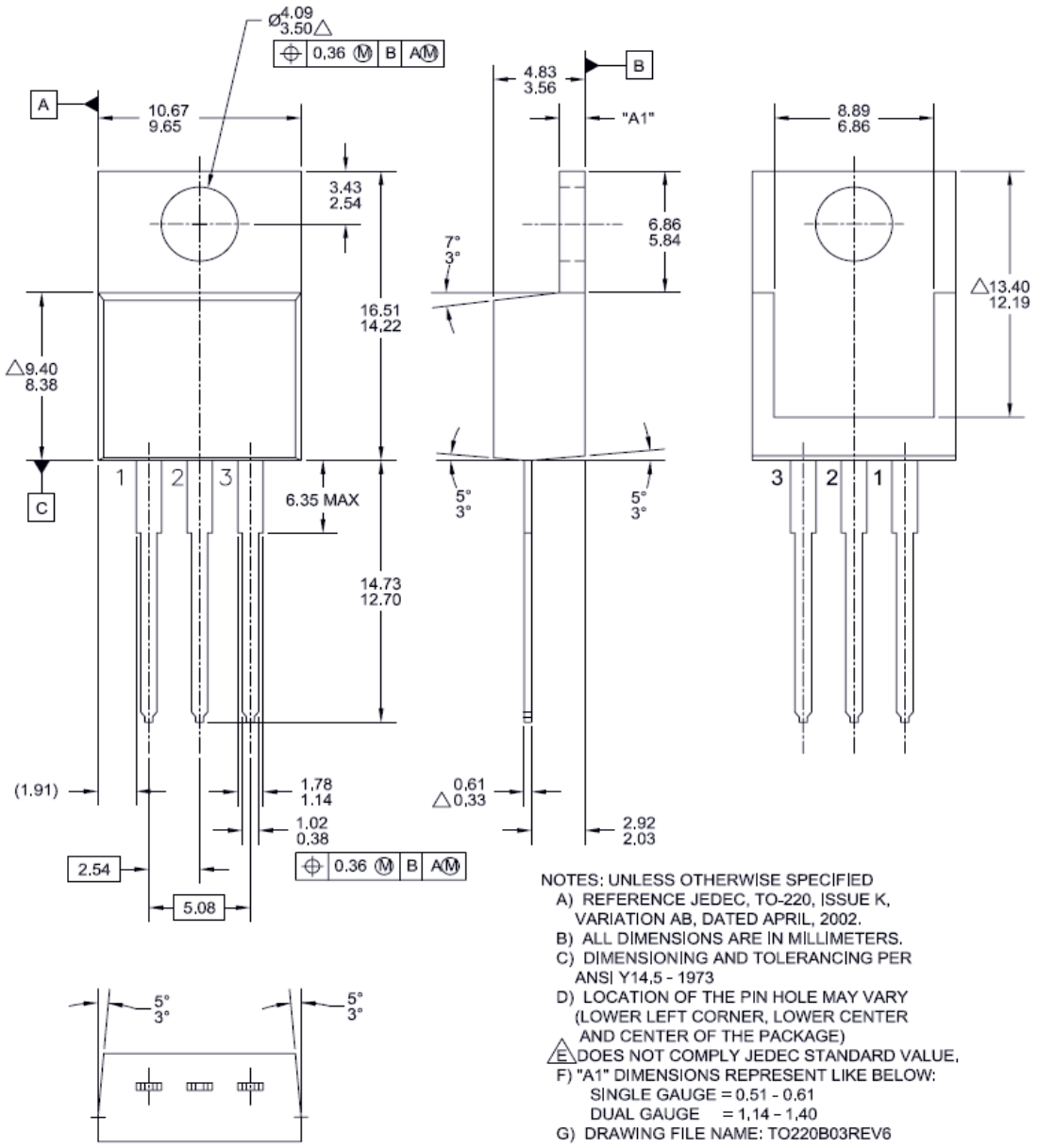
Peak Diode Recovery dv/dt Test Circuit & Waveforms





Package Dimensions

TO-220



NOTES: UNLESS OTHERWISE SPECIFIED

A) REFERENCE JEDEC, TO-220, ISSUE K, VARIATION AB, DATED APRIL, 2002.
B) ALL DIMENSIONS ARE IN MILLIMETERS.
C) DIMENSIONING AND TOLERANCING PER ANSI Y14,5 - 1973
D) LOCATION OF THE PIN HOLE MAY VARY (LOWER LEFT CORNER, LOWER CENTER AND CENTER OF THE PACKAGE)
△E DOES NOT COMPLY JEDEC STANDARD VALUE,
F) "A1" DIMENSIONS REPRESENT LIKE BELOW:
SINGLE GAUGE = 0,51 - 0,61
DUAL GAUGE = 1,14 - 1,40
G) DRAWING FILE NAME: TO220B03REV6

Dimensions in Millimeters

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Datasheet Identification	Product Status	Definition
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Preliminary	First Production	Datasheet contains preliminary data; supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve design.
No Identification Needed	Full Production	Datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve the design.
Obsolete	Not In Production	Datasheet contains specifications on a product that is discontinued by Fairchild Semiconductor. The datasheet is for reference information only.

Rev. I64

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